IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Manabu SUTOH et al. Confirmation No.: 8510

Application No.: 10/521,287 Docket No.: 71,051-001

Filed: August 08, 2005 Group Art Unit: 1796

Examiner: Loewe, Robert S.

For: SILICONE-BASED ADHESIVE SHEET, METHOD OF BONDING A

SEMICONDUCTOR CHIP TO A CHIP ATTACHMENT COMPONENT, AND A SEMICONDUCTOR DEVICE

SUPPLEMENTAL AMENDMENT

Mail Stop: Amendment Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Dear Sir:

In response to a telephonic interview with the Examiner on December 18, 2008, and further in response to the Final Office Action from the Examiner dated August 4, 2008, please amend the claims as follows and consider the accompanying remarks. A complete listing of all claims pending in the application is included in accordance with 37 CFR § 1.121.

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